

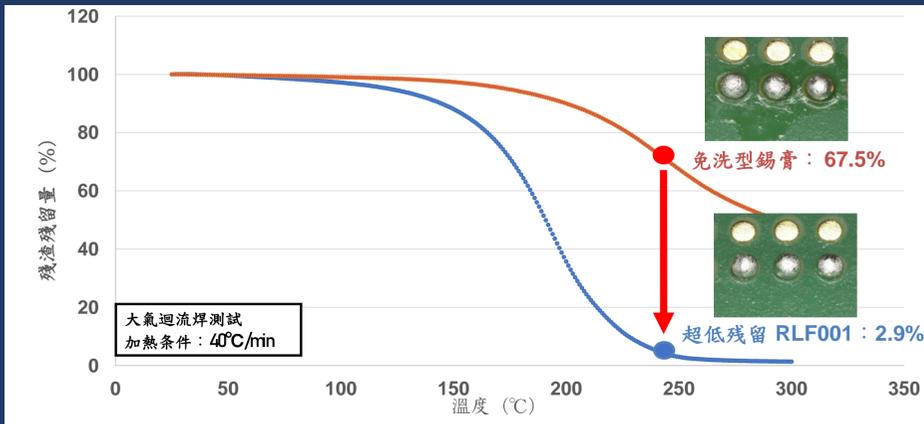
超低殘留助焊劑

Ultra-low Residue Flux

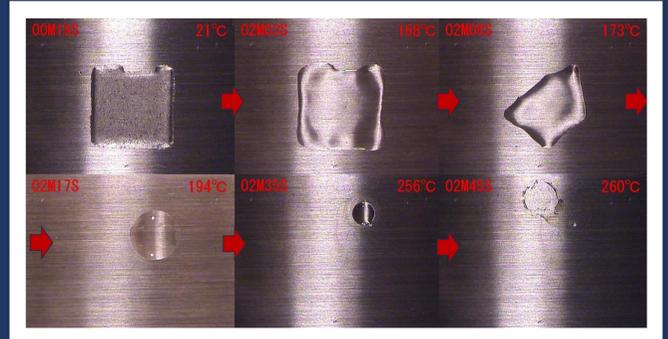
減少洗淨程序

錫凸塊產品專用

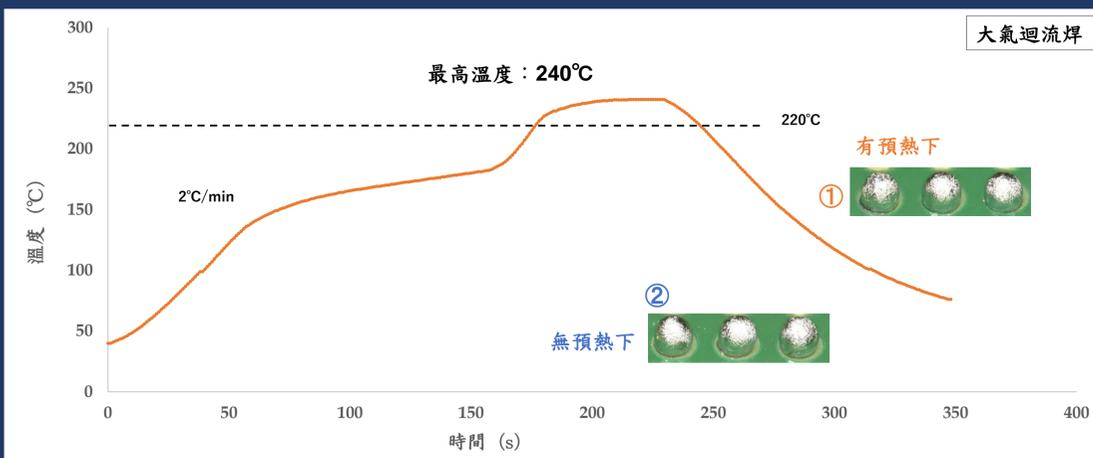
適用各種迴流焊接



比起免洗型產品，可大幅降低助焊劑殘量



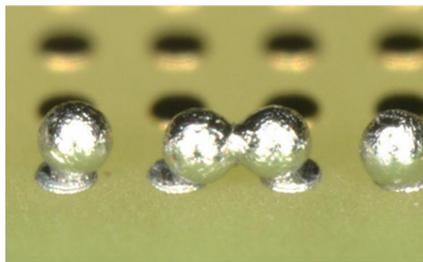
加熱後實際揮發情況



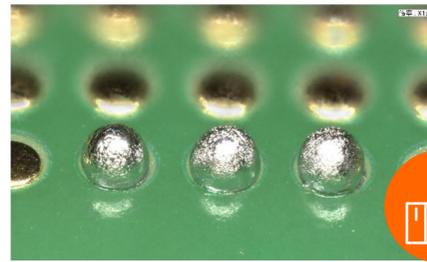
即使是急速加熱仍可實現
超低殘留同時保持其潤濕性！

適用於各種迴流焊接條件！
常見的大氣加熱也可實現

錫球維持分離

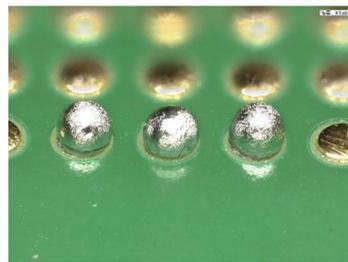


相鄰的錫球連接

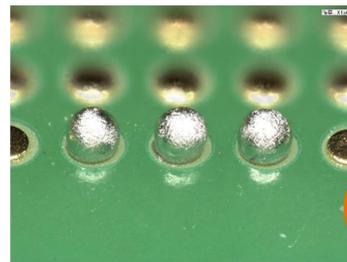


錫球保持獨立並熔融於基板

可完全熔融



錫球表面凹陷

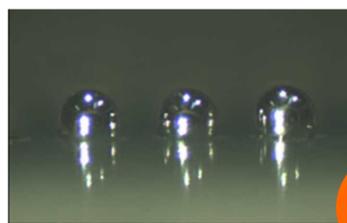


錫球表面平順

錫球高度
保持一致



錫膏熔融不穩定導致
錫球高度參差不齊



錫膏熔融穩定
使錫球高度一致

